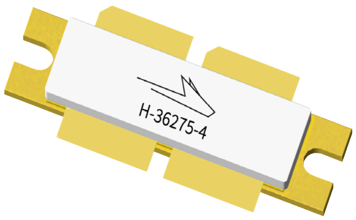
GTVA101K42EV

Thermally-Enhanced High Power RF GaN on SiC HEMT
1400 W, 50 V, DC – 1400 MHz



Package Types: H-36275-4
PN's: GTVA101K42EV

Description

The GTVA101K42EV is a 1400 W GaN on SiC high electron mobility transistor (HEMT) for use in the DC to 1400 MHz frequency band. It is a input matched, high efficiency device in a thermally-enhanced package with bolt-down flange.

Features

- GaN on SiC HEMT technology
- Input matched
- Typical pulsed CW performance, 960 – 1400 MHz, 50 V, single side, 128 µs pulse width, 10% duty cycle
  - Output power at P_{3dB} = 1400 W
  - Efficiency = 68%
  - Gain = 17 dB
- Pb-free and RoHS compliant

RF Characteristics[1]

Pulsed CW specifications (tested in Wolfspeed test fixture)
V_{DD} = 50 V, I_{DQ} = 75 mA, $P_{OUT(P3dB)}$ = 1400 W peak, ƒ = 1030 MHz, pulse width = 128 µs, duty cycle = 10%

Characteristics	Symbol	Min.	Typ.	Max.	Units
Linear Gain	G_{ps}	17	19	–	dB
Return Loss	R	–	-19	-12	dB
Drain Efficiency	η_D	65	69	–	%
Output Mismatch Stress[2]	VSWR	–	–	10:1	Ψ

Notes:
[1] All published data at T_{CASE} = 25 °C unless otherwise indicated.
[2] No damage at all phase angles, V_{DD} = 50 V, I_{DQ} = 75 mA, P_{OUT} = 1400 W pulsed.
[3] ESD: Electrostatic discharge sensitive device—observe handling precautions!

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DC Characteristics

Characteristics	Conditions	Symbol	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	V_{GS} = -8 V, I_D = 83.6 mA	$V_{(BR)DSS}$	125	–	–	V
Drain-Source Leakage Current	V_{GS} = -6 V, V_{DS} = 2 V	I_{DSS}	62.7	75.5	–	A
Gate Threshold Voltage	V_{DS} = 10 V, I_D = 83.6 mA	$V_{GS(th)}$	-3.8	-3.0	-2.7	V

Recommended Operating Conditions

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Units
Drain Operating Voltage	–	V_{DD}	0	–	50	V
Gate Quiescent Voltage	V_{DS} = 50 V, I_D = 100 mA	$V_{GS(Q)}$	–	-3.1	–	V

Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Drain-Source Voltage	V_{DSS}	150	V
Gate-Source Voltage	V_{GS}	-10 to +2	V
Gate Current	I_G	167	mA
Drain Current	I_D	48	A
Junction Temperature	T_J	225	°C
Storage Temperature Range	T_{STG}	-65 to +150	°C

Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range (V_{DD}) specified above.

Thermal Characteristics

Parameter	Symbol	Value	Units
Thermal Resistance, Junction to Case[1]	$R_{\theta JC}$	0.127	°C/W
Thermal Resistance, Junction to Case[2]	$R_{\theta JC}$	0.167	°C/W
Thermal Resistance, Junction to Case[3]	$R_{\theta JC}$	0.166	°C/W

Notes:

[1] T_{CASE} = 85 °C, P_{DISS} = 700 W, 100 µs pulse width, 10% duty cycle.

[2] T_{CASE} = 85 °C, P_{DISS} = 700 W, 500 µs pulse width, 10% duty cycle.

[3] T_{CASE} = 85 °C, P_{DISS} = 700 W, Mode-S signal.

Electrical Characteristics When Tested in GTVA101K42EV-AMP2

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
RF Characteristics[1] (T_C = 25 °C, F_0 = 1.2 - 1.4 GHz Unless Otherwise Noted)						
Output Power[2]	P_{OUT}	–	61	–	dBm	V_{DD} = 50 V, I_{DQ} = 1.8 A, P_{IN} = 44 dBm
Power Added Efficiency[2]	η	–	55	–	%	V_{DD} = 50 V, I_{DQ} = 1.8 A, P_{IN} = 44 dBm
Gain[2]	G	–	17	–	dB	V_{DD} = 50 V, I_{DQ} = 1.8 A, P_{IN} = 44 dBm

Notes:

[1] Measured in the GTVA101K42EV-AMP2 application circuit.

[2] Pulsed 500 µs, 10% duty cycle.

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, pulse width = 500 µs, duty cycle = 10%, P_{IN} = 44 dBm, T_{BASE} = +25 °C

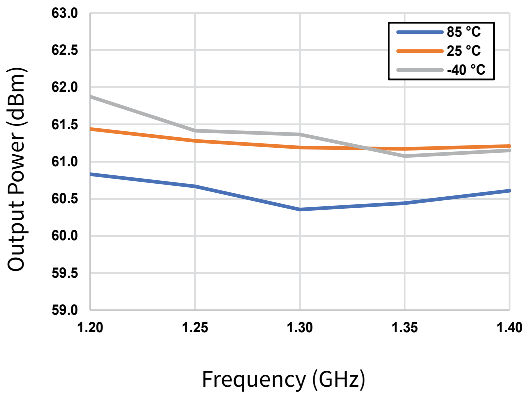


Figure 1. Output Power vs Frequency as a Function of Temperature

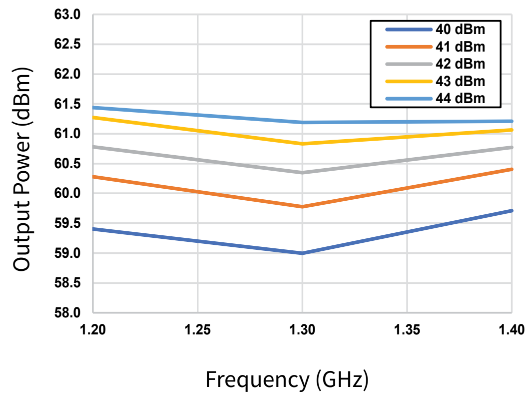


Figure 2. Output Power vs Frequency as a Function of Input Power

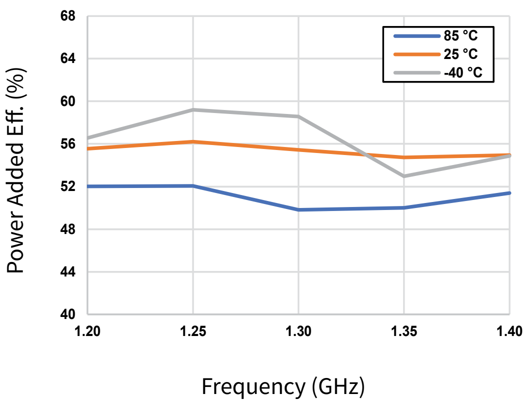


Figure 3. Power Added Eff. vs Frequency as a Function of Temperature

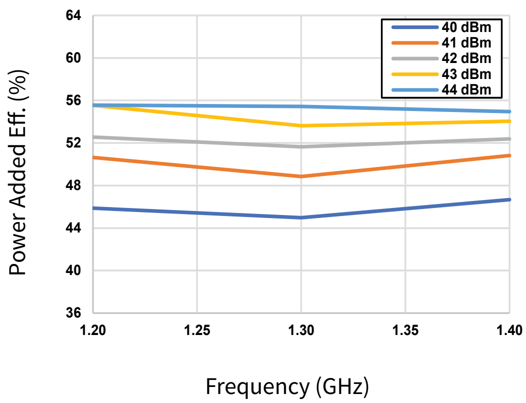


Figure 4. Power Added Eff. vs Frequency as a Function of Input Power

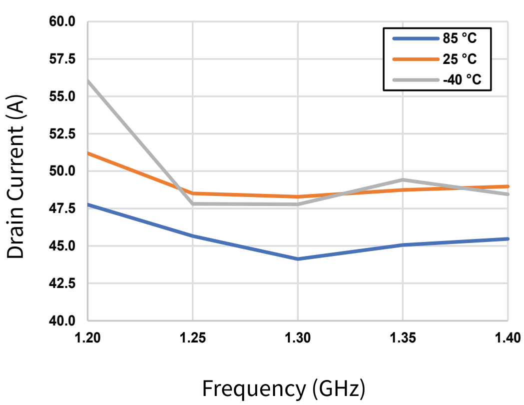


Figure 5. Drain Current vs Frequency as a Function of Temperature

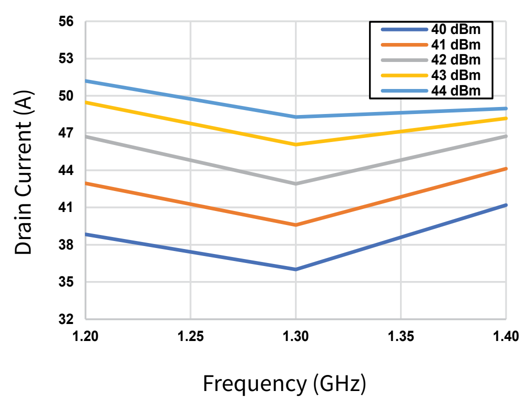


Figure 6. Drain Current vs Frequency as a Function of Input Power

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, pulse width = 500 µs, duty cycle = 10%, P_{IN} = 44 dBm, T_{BASE} = +25 °C

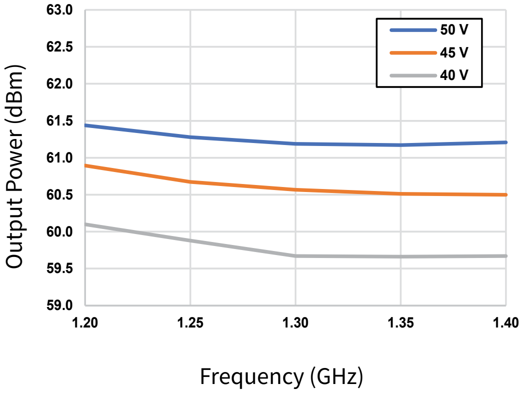


Figure 7. Output Power vs Frequency as a Function of V_D

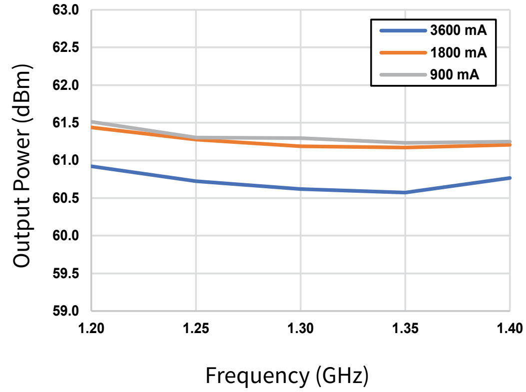


Figure 8. Output Power vs Frequency as a Function of I_{DQ}

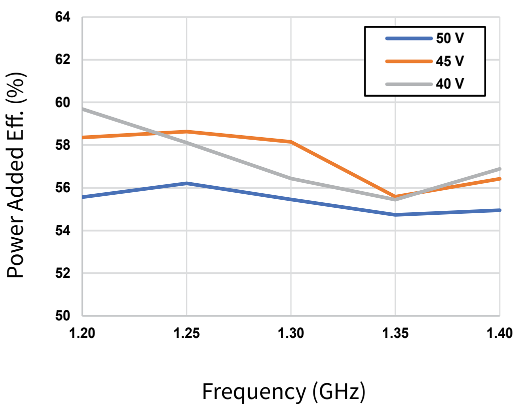


Figure 9. Power Added Eff. vs Frequency as a Function of V_D

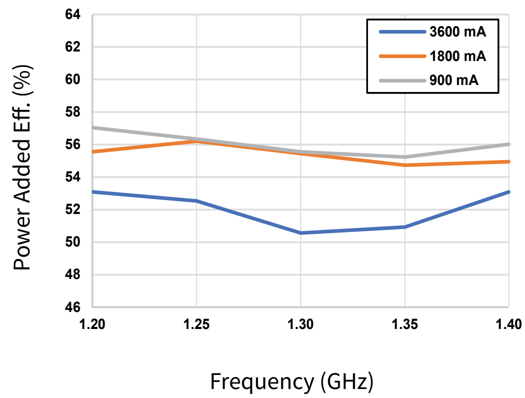


Figure 10. Power Added Eff. vs Frequency as a Function of I_{DQ}

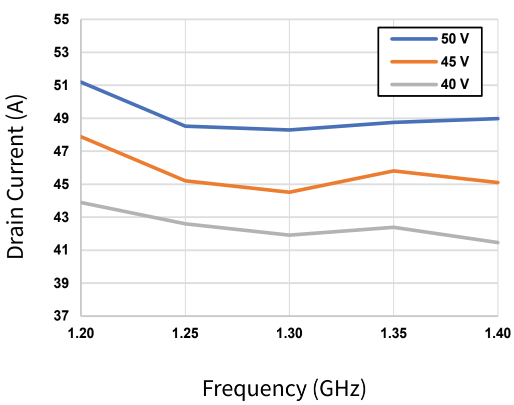


Figure 11. Drain Current vs Frequency as a Function of V_D

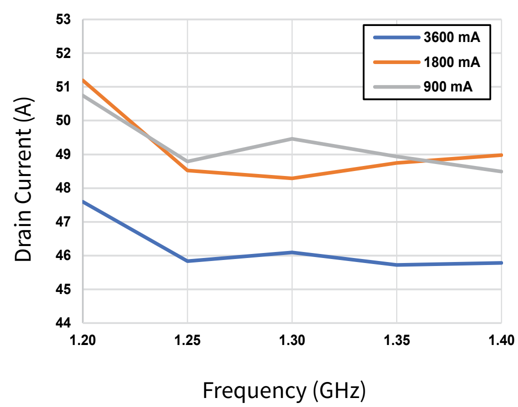


Figure 12. Drain Current vs Frequency as a Function of I_{DQ}

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, pulse width = 500 µs, duty cycle = 10%, P_{IN} = 44 dBm, T_{BASE} = +25 °C

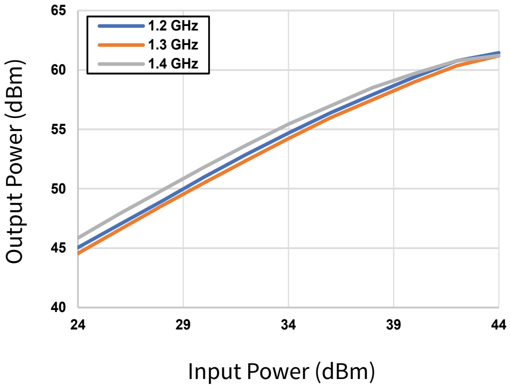


Figure 13. Output Power vs Input Power as a Function of Frequency

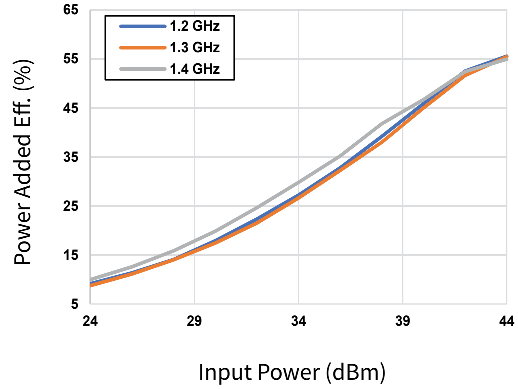


Figure 14. Power Added Eff. vs Input Power as a Function of Frequency

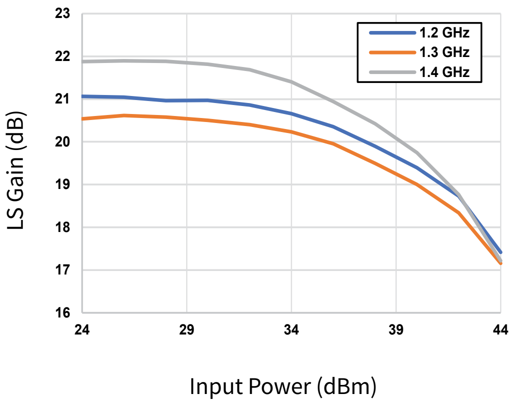


Figure 15. Large Signal Gain vs Input Power as a Function of Frequency

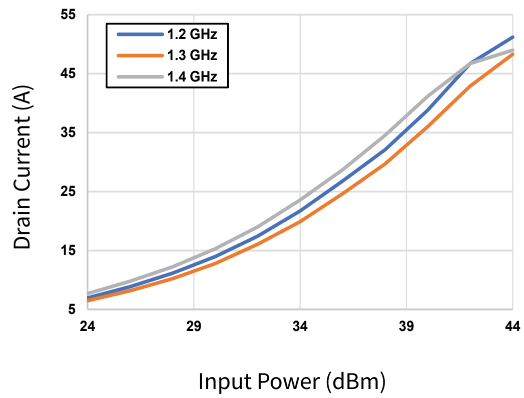


Figure 16. Drain Current vs Input Power as a Function of Frequency

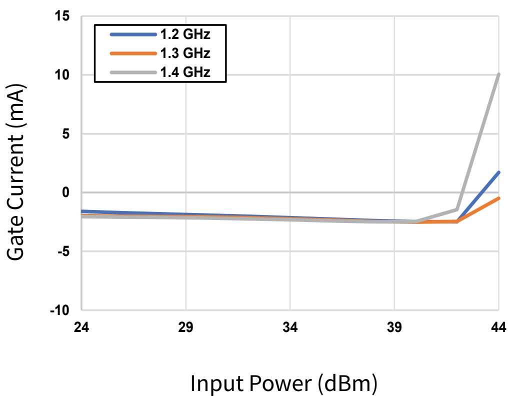


Figure 17. Gate Current vs Input Power as a Function of Frequency

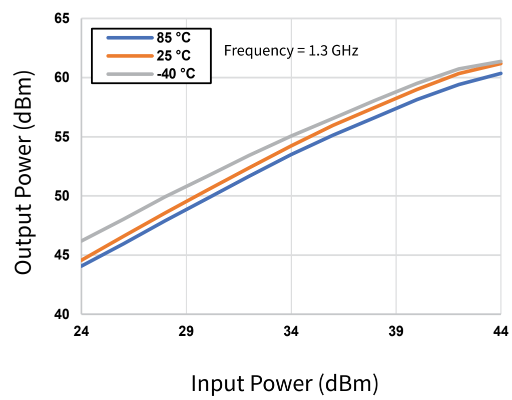


Figure 18. Output Power vs Input Power as a Function of Temperature

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, pulse width = 500 µs, duty cycle = 10%, P_{IN} = 44 dBm, T_{BASE} = +25 °C

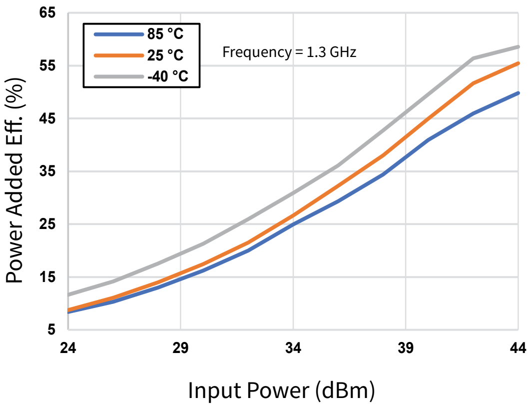


Figure 19. Power Added Eff. vs Input Power as a Function of Temperature

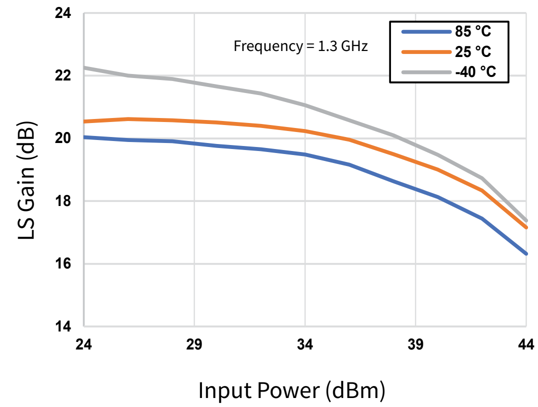


Figure 20. Large Signal Gain vs Input Power as a Function of Temperature

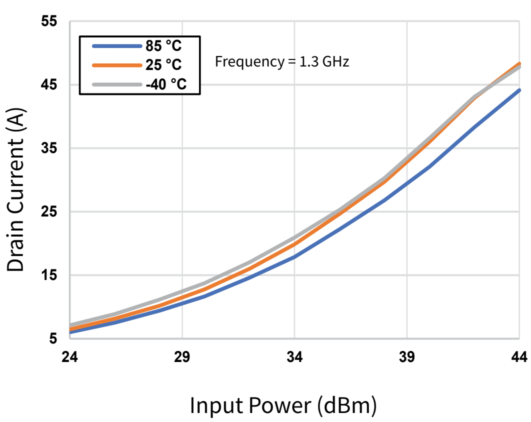


Figure 21. Drain Current vs Input Power as a Function of Temperature

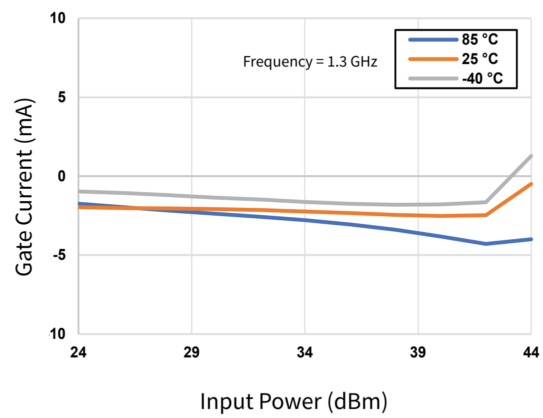


Figure 22. Gate Current vs Input Power as a Function of Temperature

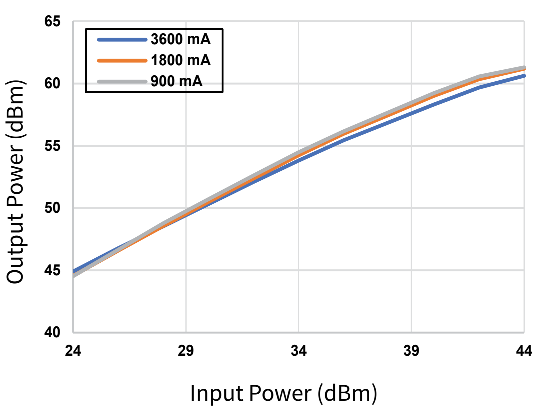


Figure 23. Output Power vs Input Power as a Function of I_{DQ}

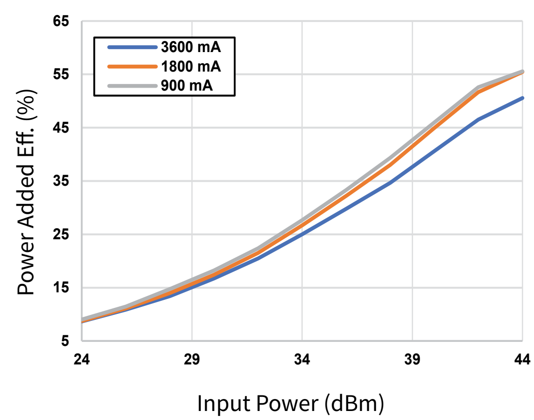


Figure 24. Power Added Eff. vs Input Power as a Function of I_{DQ}

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, pulse width = 500 µs, duty cycle = 10%, P_{IN} = 44 dBm, T_{BASE} = +25 °C

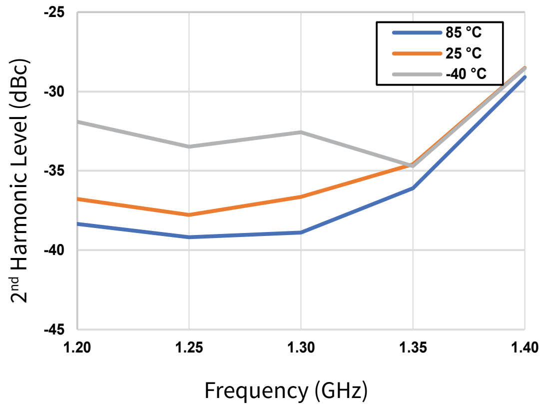


Figure 25. 2nd Harmonic vs Frequency as a Function of Temperature

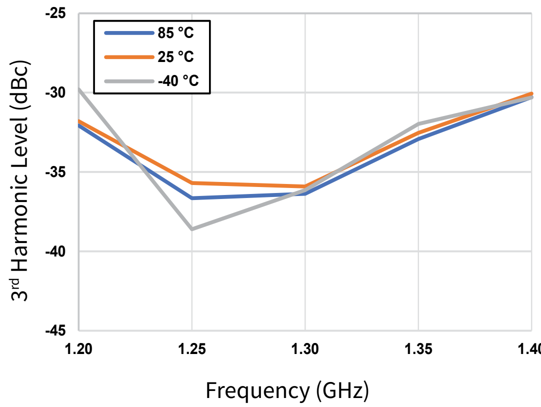


Figure 26. 3rd Harmonic vs Frequency as a Function of Temperature

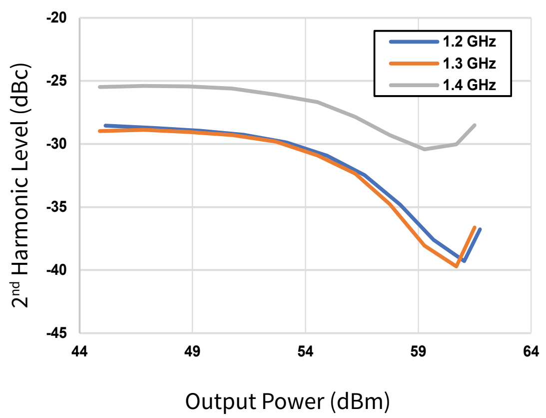


Figure 27. 2nd Harmonic vs Output Power as a Function of Frequency

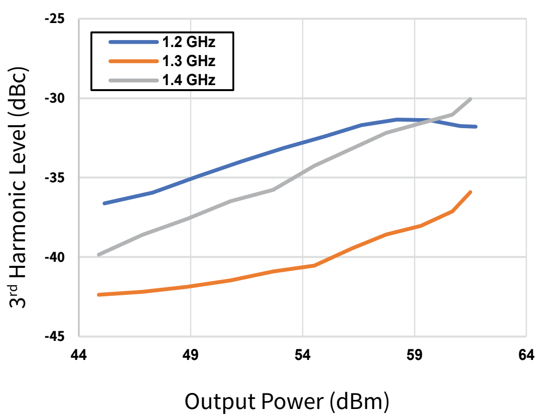


Figure 28. 3rd Harmonic vs Output Power as a Function of Frequency

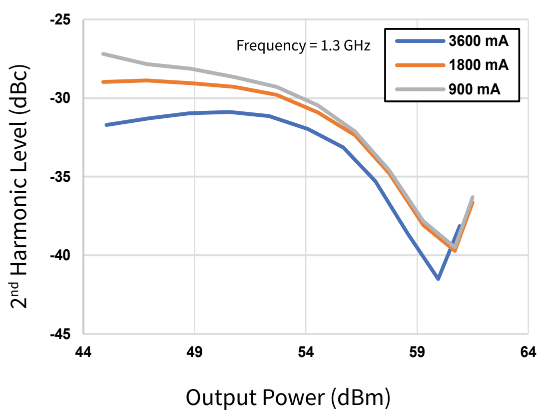


Figure 29. 2nd Harmonic vs Output Power as a Function of I_{DQ}

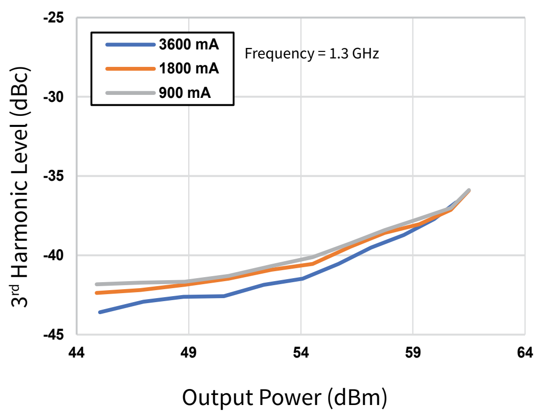


Figure 30. 3rd Harmonic vs Output Power as a Function of I_{DQ}

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, P_{IN} = -20 dBm, T_{BASE} = +25 °C

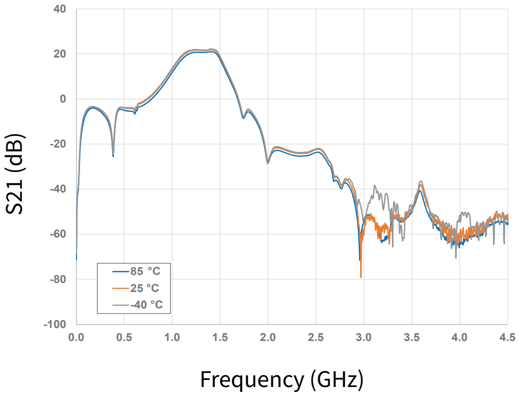


Figure 31. Gain vs Frequency as a Function of Temperature

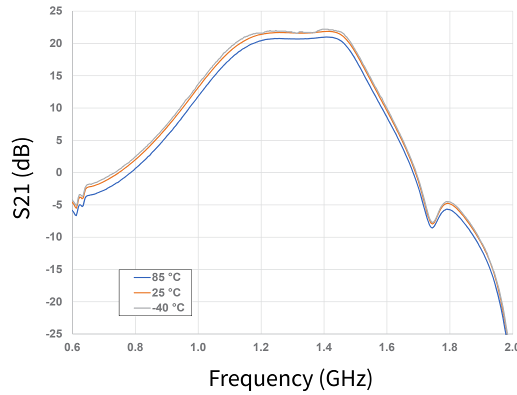


Figure 32. Gain vs Frequency as a Function of Temperature

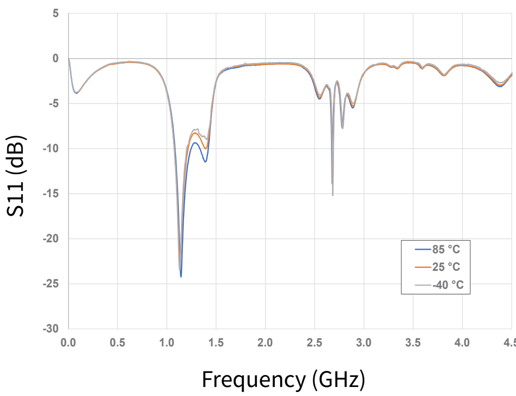


Figure 33. Input RL vs Frequency as a Function of Temperature

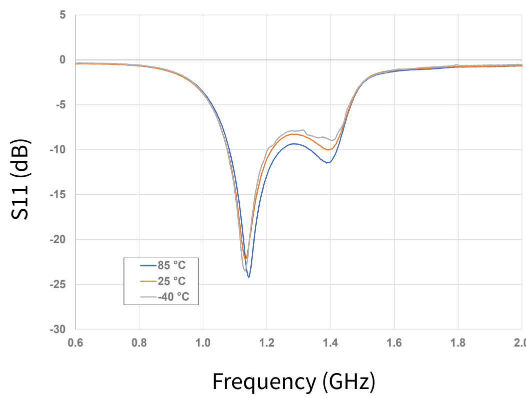


Figure 34. Input RL vs Frequency as a Function of Temperature

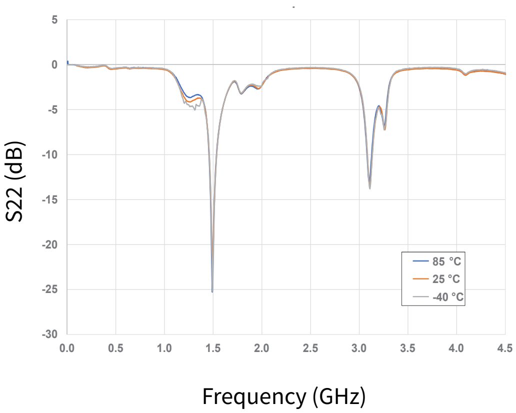


Figure 35. Output RL vs Frequency as a Function of Temperature

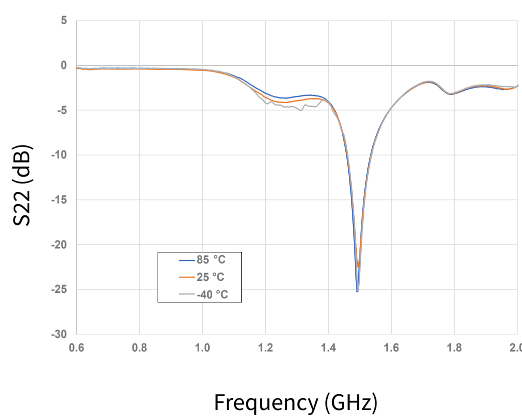


Figure 36. Output RL vs Frequency as a Function of Temperature

Typical Performance of the GTVA101K42EV-AMP2

Test conditions unless otherwise noted: V_D = 50 V, I_{DQ} = 1800 mA, P_{IN} = -20 dBm, T_{BASE} = +25 °C

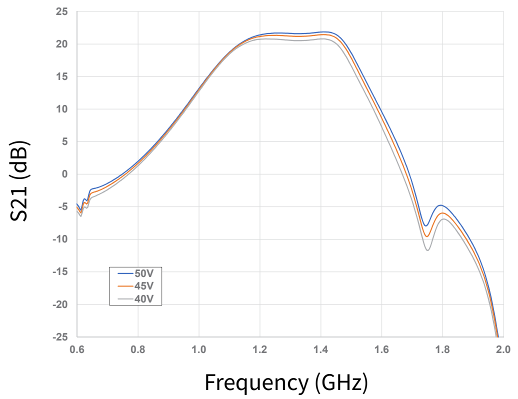


Figure 37. Gain vs Frequency as a Function of Voltage

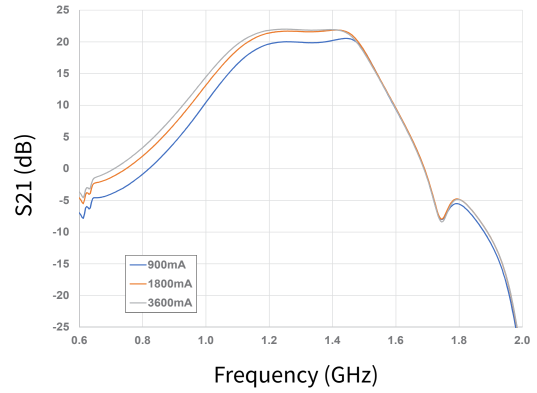


Figure 38. Gain vs Frequency as a Function of I_{DQ}

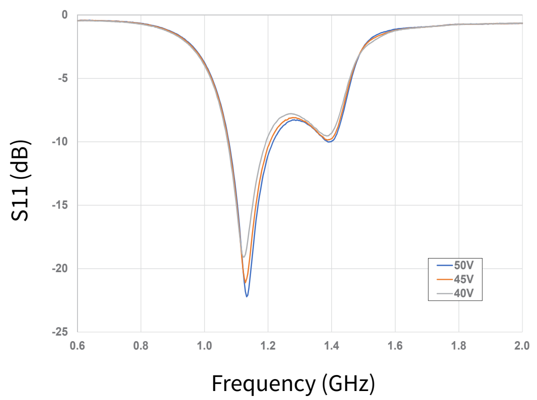


Figure 39. Input RL vs Frequency as a Function of Voltage

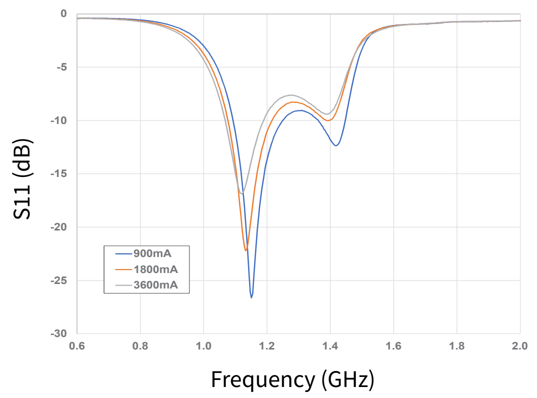


Figure 40. Input RL vs Frequency as a Function of I_{DQ}

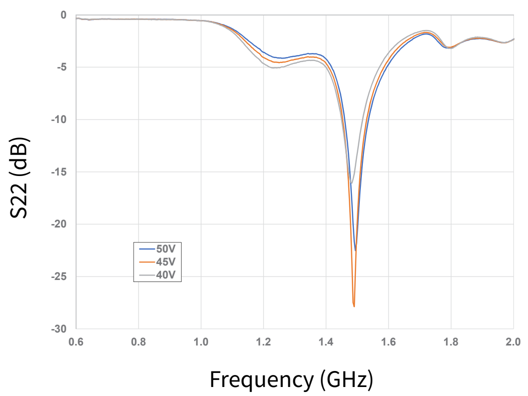


Figure 41. Output RL vs Frequency as a Function of Voltage

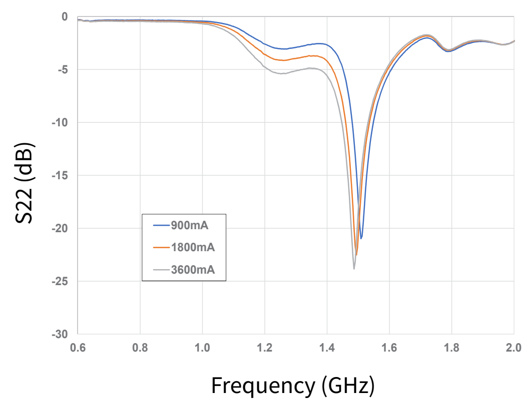
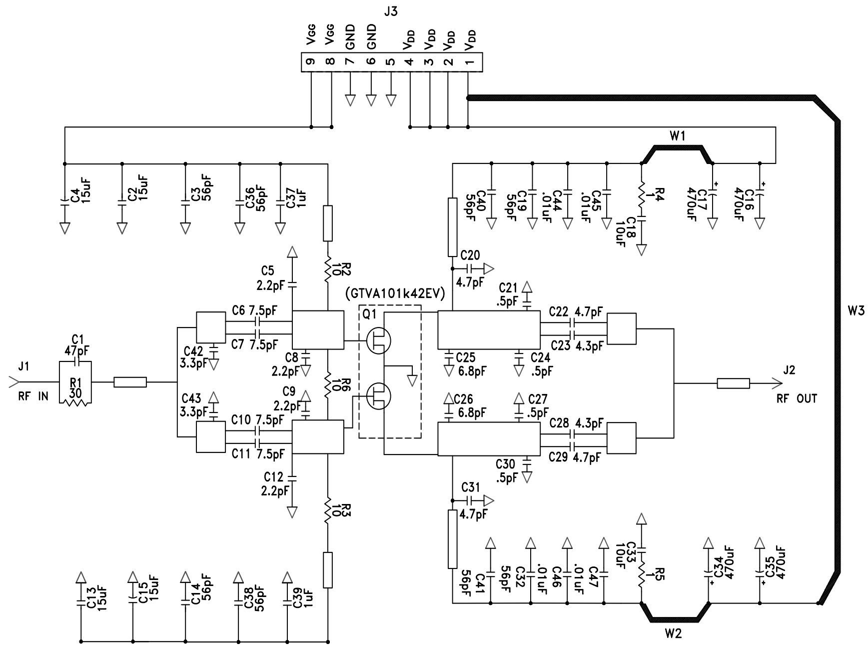
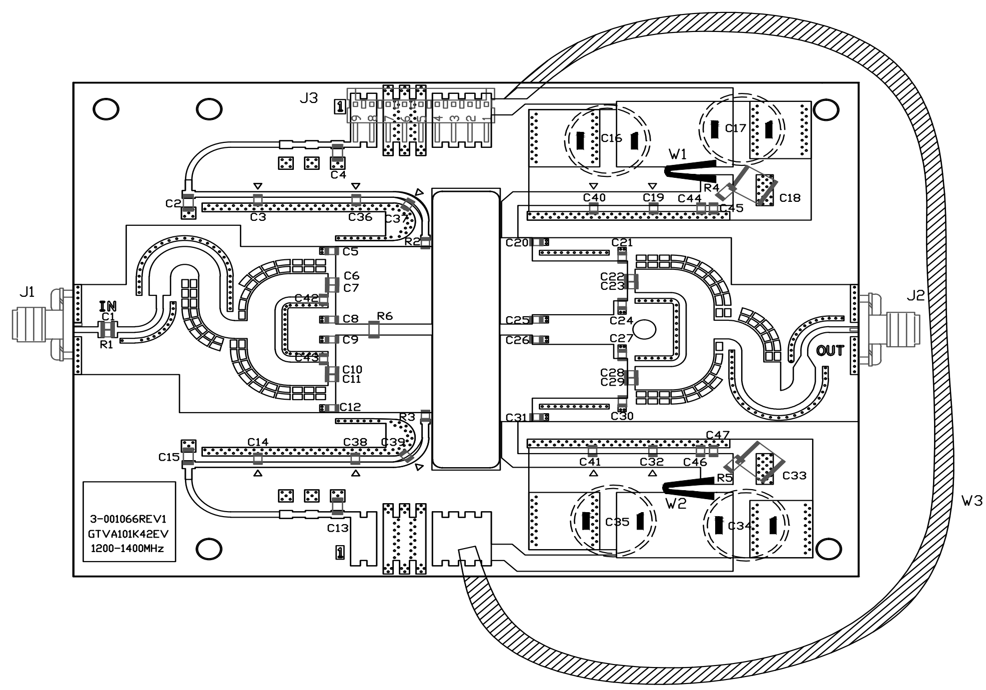


Figure 42. Output RL vs Frequency as a Function of Voltage

GTVA101K42EV-AMP2 Application Circuit Schematic



GTVA101K42EV-AMP2 Application Circuit



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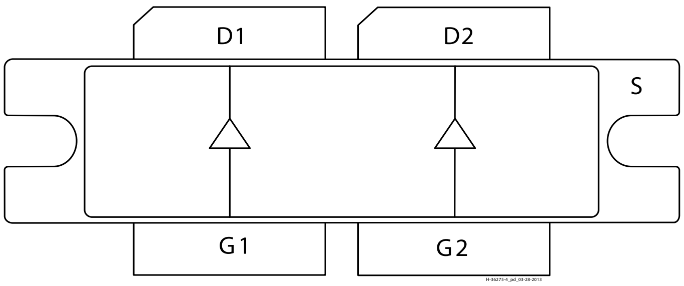
GTVA101K42EV-AMP2 Application Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 30 OHMs, +/- 1%, 0805, 1/8 W, YAGEO	1
R2, R3	RES, 10 OHMS, +/- 1%, 0805, 1/8 W, YAGEO	2
R4, R5	RES, 1 OHMS, +/- 5%, 1206, 125 mW, AVX	2
R6	RES, 10 OHMS, +/1%, 1206, 1/4 W	1
C1	CAP, 47 pF, +/- 5%, 250 V, 0805, ATC 600 F	1
C2, C4, C13, C15	CAP, 15 uF, +/-20%, 10 V, X7s, 1206, TDK	4
C3, C14, C19, C32, C36, C38, C40, C41	CAP, 56 pF, +/- 5%, 250 V, 0805, ATC, 600 F	8
C5, C8, C9, C12	CAP, 2.2 pF, +/- .1 pF, 250 V, 0805, ATC 600 F	4
C6, C7, C10, C11	CAP, 7.5 pF, +/- .25 pF, 250 V, 0805, ATC 600 F	4
C16, C17, C34, C35	CAP, 470 uF, +/-20%, 80 V, Electrolytic, Vishay	4
C18, C33	CAP, 10 uF, +/- 10%, 100 V, X7S, 2220, TDK	2
C20, C22, C29, C31	CAP, 4.7 pF, +/- .25 pF, 250 V, 0805, ATC 600 F	4
C21, C24, C27, C30	CAP, .5 pF, +/- .05 pF, 250 V, 0805, ATC 600 F	4
C23, C28	CAP, 4.3 pF, +/-.25 pF, 250 V, 0805, ATC 600 F	2
C25, C26	CAP, 6.8 pF, +/-.25 pF, 250 V, 0805, ATC 600 F	2
C37, C39	CAP, 1 uF, 100 V, X7S, 0805, Murata	2
C44, C45, C46, C47	CAP, .01 uF, 50 V, X7R	4
C42, C43	CAP, 3.3 pF, +/-.1 pF, 250 V, 0805, ATC 600 F	2
W1, W2	Wire, 3.25", 18 AWG	2
W3	Wire, 7", 12 AWG	1
Q1	Transistor, GTVA101K42EV	1

Pinout Diagram (Top View)



Pin	Desc.
D1	Drain Device 1
D2	Drain Device 2
G1	Gate Device 1
G2	Gate Device 2
S	Source (Flange)

Package Outline Specifications

Package H-36275-4

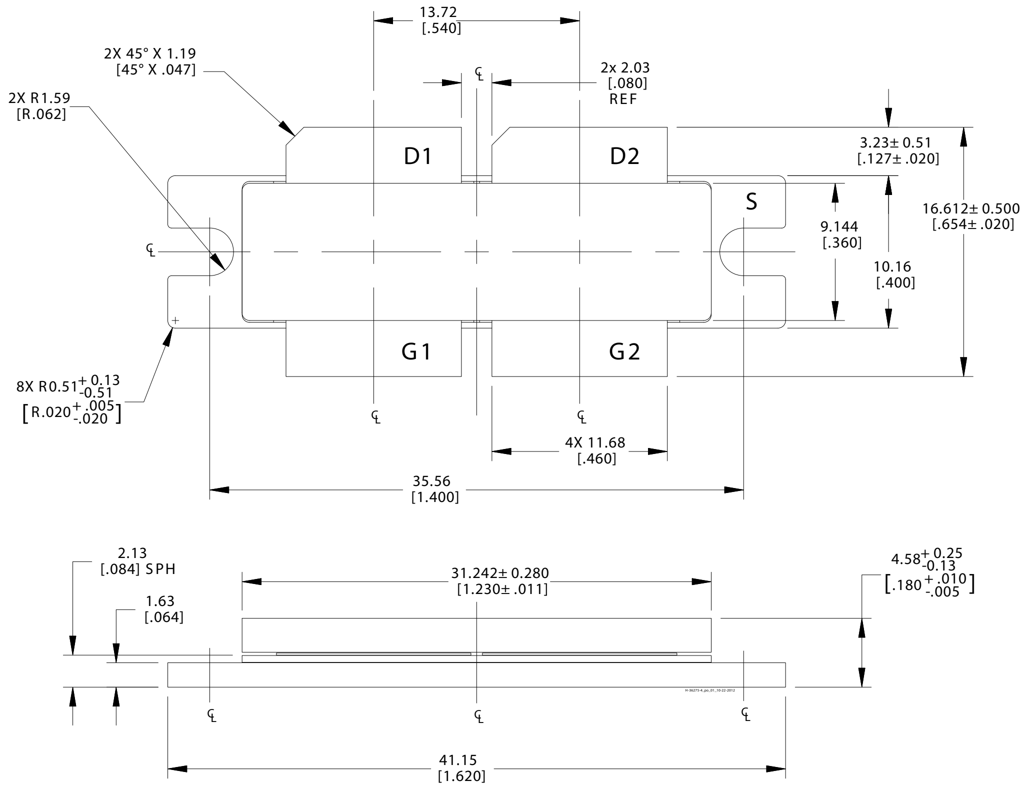
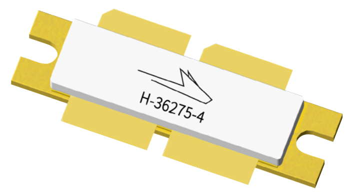
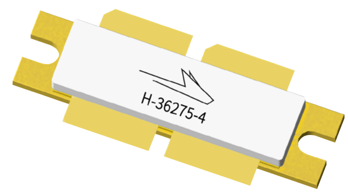
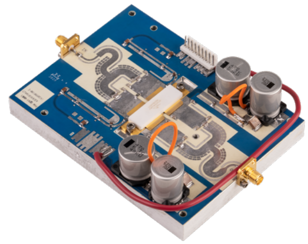


Diagram Notes—unless otherwise specified:

1. Interpret dimensions and tolerances per ASME Y14.5M-1994.
2. Primary dimensions are mm. Alternate dimensions are inches.
3. All tolerances ± 0.127 [.005] unless specified otherwise.
4. Pins: D1, D2 – drains; G1, G2 – gates; S – source.
5. Lead thickness: 0.127 ±0.051 mm [0.005 ±0.002 inch].
6. Gold plating thickness: 1.14 ± 0.38 micron [45 ± 15 microinch].

Product Ordering Information

Order Number	Description	Unit of Measure	Image
GTVA101K42EV-V1-R0	GaN HEMT, Tape & Reel, 50 pcs	Each	
GTVA101K42EV-V1-R2	GaN HEMT, Tape & Reel, 250 pcs	Each	
LTN/GTVA101K42EV V1	Test Board with GaN HEMT Installed IFF, 1030 MHz	Each	
GTVA101K42EV-AMP2	Test Board with GaN HEMT Installed L-Band Radar, 1.2 - 1.4 GHz	Each	

For more information, please contact:

4600 Silicon Drive
Durham, NC 27703 USA
Tel: +1.919.313.5300
www.wolfspeed.com/RF

Sales Contact
RFSales@wolfspeed.com

RF Product Marketing Contact
RFMarketing@wolfspeed.com

Notes & Disclaimer

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